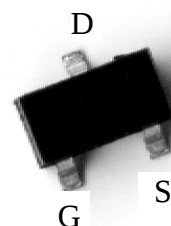


30V N-Channel Enhancement Mode MOSFET

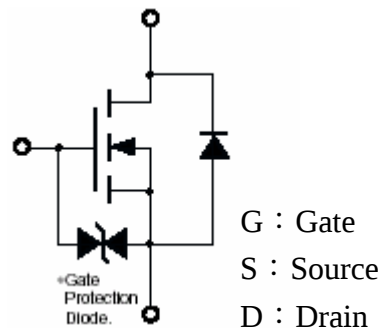
Features:

- Simple drive requirement
- Small package outline
- Pb-free lead plating and halogen-free package

SOT-323



BV_{DSS}	30V
I_D	780mA
$R_{DS(on)}@V_{GS}=4.5V, I_D=400mA$	310m Ω (typ)
$R_{DS(on)}@V_{GS}=2.5V, I_D=250mA$	440m Ω (typ)
$R_{DS(on)}@V_{GS}=1.8V, I_D=150mA$	580m Ω (typ)



Ordering Information

Device	Package	Shipping
KWS3078N03	SOT-323 (Pb-free lead plating and halogen-free package)	3000 pcs / Tape & Reel

Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Limits	Unit
Drain-Source Voltage	V _{DS}	30	V
Gate-Source Voltage	V _{GS}	±8	
Continuous Drain Current @ T _A =25°C (Note 3)	I _D	780	mA
Continuous Drain Current @ T _A =70°C (Note 3)		620	
Pulsed Drain Current (Notes 1, 2)	I _{DM}	3.5	A
Maximum Power Dissipation@ T _A =25°C	P _D	0.35	W
Linear Derating Factor		0.003	W/°C
ESD susceptibility		1000 (Note 4)	V
Operating Junction and Storage Temperature	T _j , T _{stg}	-55~+150	°C

- Note : 1. Pulse width limited by maximum junction temperature.
 2. Pulse width ≤ 300μs, duty cycle ≤ 2%.
 3. Surface mounted on 1 in² copper pad of FR-4 board, t ≤ 10 seconds.
 4. Human body model, 1.5kΩ in series with 100pF.

Thermal Performance

Parameter	Symbol	Limit	Unit
Thermal Resistance, Junction-to-Ambient(PCB mounted) (Note)	R _{th,ja}	360	°C/W

Note : Surface mounted on 1 in² copper pad of FR-4 board, t ≤ 10 seconds.

Electrical Characteristics (T_j=25°C, unless otherwise noted)

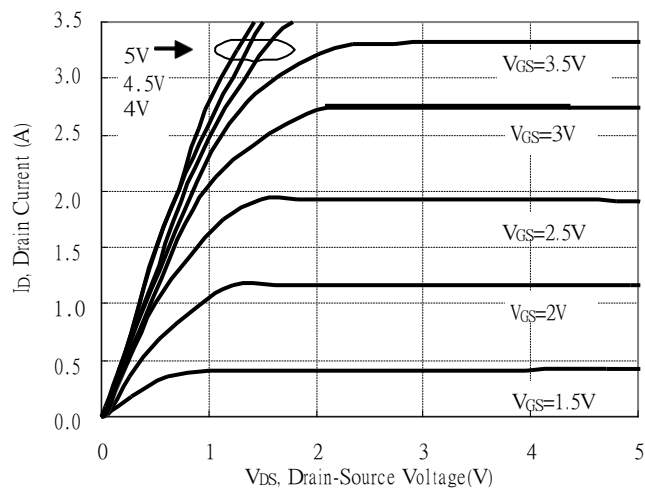
Symbol	Min.	Typ.	Max.	Unit	Test Conditions
Static					
BV _{DSS}	30	-	-	V	V _{GS} =0, I _D =250μA
ΔBV _{DSS} /ΔT _j	-	0.02	-	V/°C	Reference to 25°C, I _D =250μA
V _{GS(th)}	0.5	0.75	1.0	V	V _{DS} =V _{GS} , I _D =250μA
I _{GSS}	-	-	±5	μA	V _{GS} =±8V, V _{DS} =0
I _{DSS}	-	-	1		V _{DS} =30V, V _{GS} =0
	-	-	10		V _{DS} =24V, V _{GS} =0 (T _j =70°C)
*R _{DS(ON)}	-	310	400	mΩ	V _{GS} =4.5V, I _D =400mA
	-	440	600		V _{GS} =2.5V, I _D =250mA
	-	580	750		V _{GS} =1.8V, I _D =150mA
*G _{FS}	-	1.2	-	S	V _{DS} =5V, I _D =400mA
Dynamic					
C _{iss}	-	58	-	pF	V _{DS} =15V, V _{GS} =0, f=1MHz
C _{oss}	-	10	-		
C _{rss}	-	6	-		

td(ON)	-	6	-	ns	VDS=15V, ID=400mA, VGS=4.5V, RG=6Ω
tr	-	7	-		
td(OFF)	-	14	-		
tf	-	4	-		
Qg	-	1.4	-	nC	VDS=24V, ID=780mA, VGS=4.5V
Qgs	-	0.2	-		
Qgd	-	0.5	-		
Source-Drain Diode					
*VSD	-	0.74	1.2	V	VGS=0V, IS=100mA

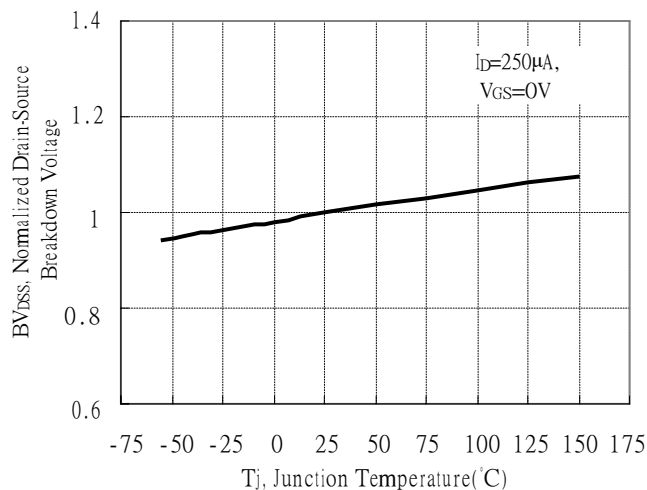
*Pulse Test : Pulse Width $\leq 300\mu s$, Duty Cycle $\leq 2\%$

Typical Characteristics

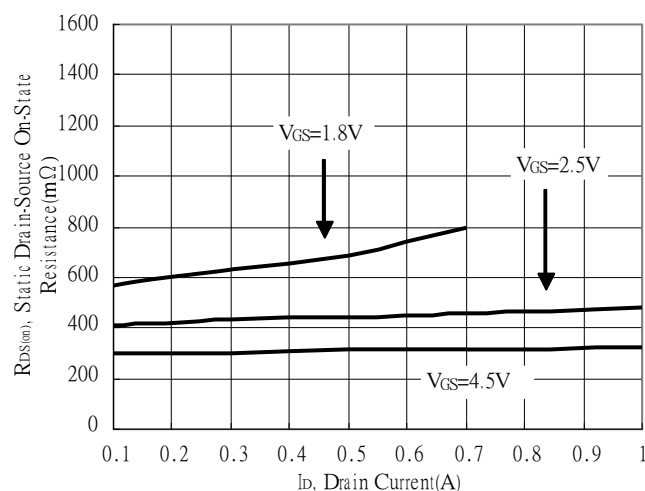
Typical Output Characteristics



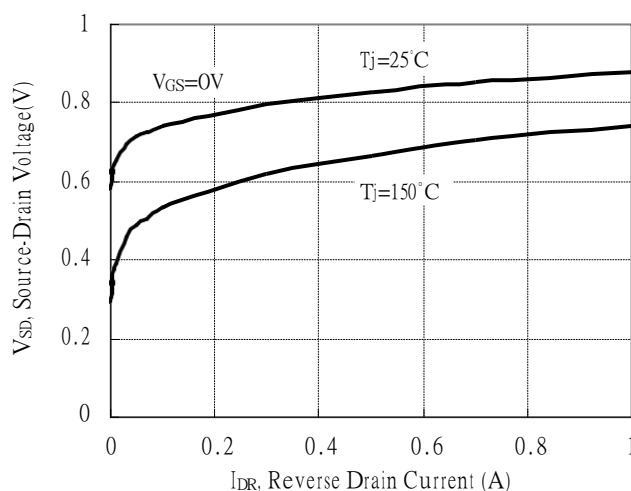
Breakdown Voltage vs Ambient Temperature



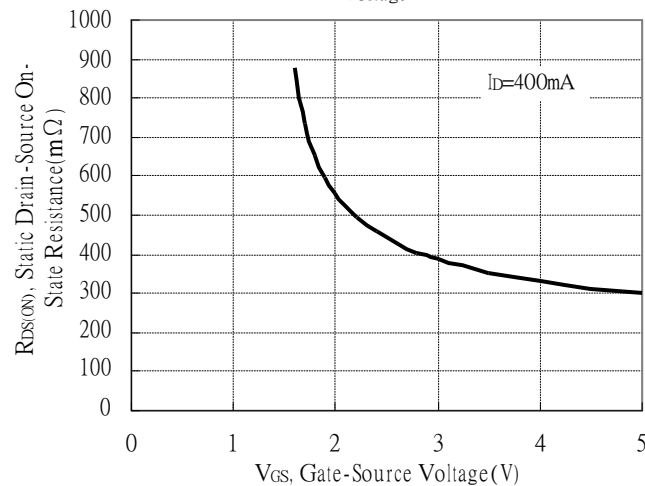
Static Drain-Source On-State resistance vs Drain Current



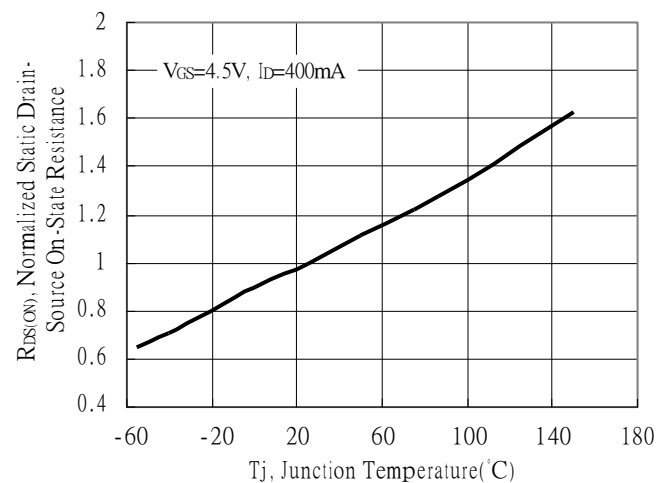
Reverse Drain Current vs Source-Drain Voltage



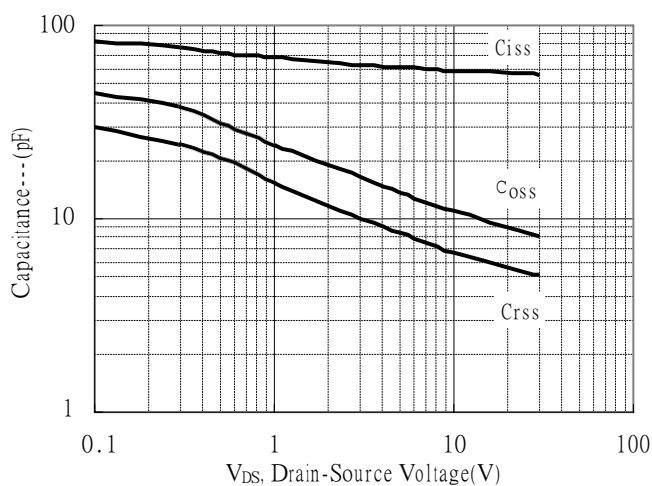
Static Drain-Source On-State Resistance vs Gate-Source Voltage



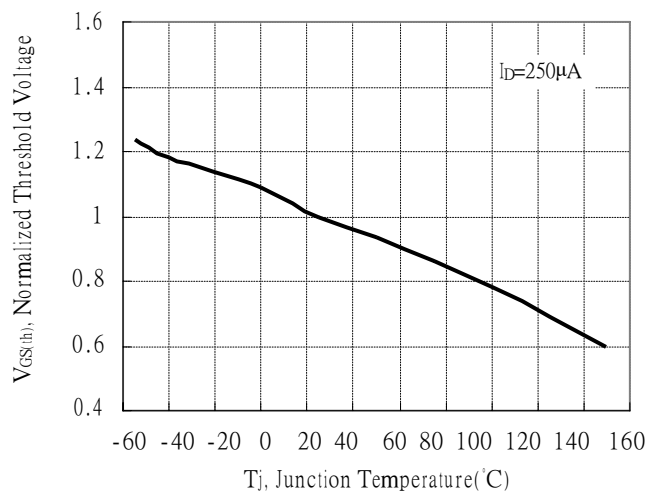
Drain-Source On-State Resistance vs Junction Temperature



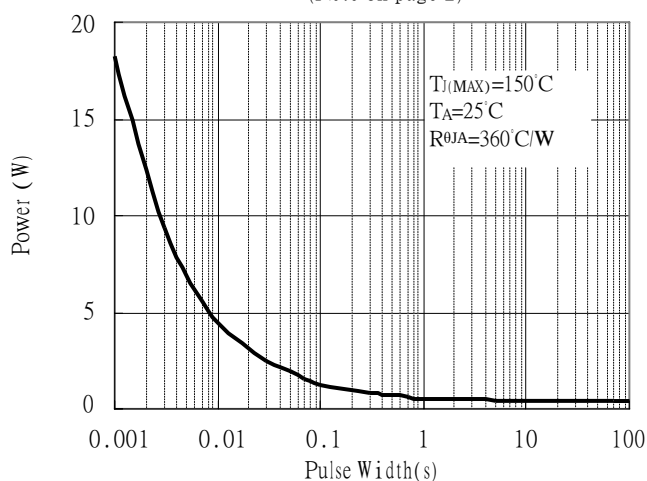
Capacitance vs Drain-to-Source Voltage



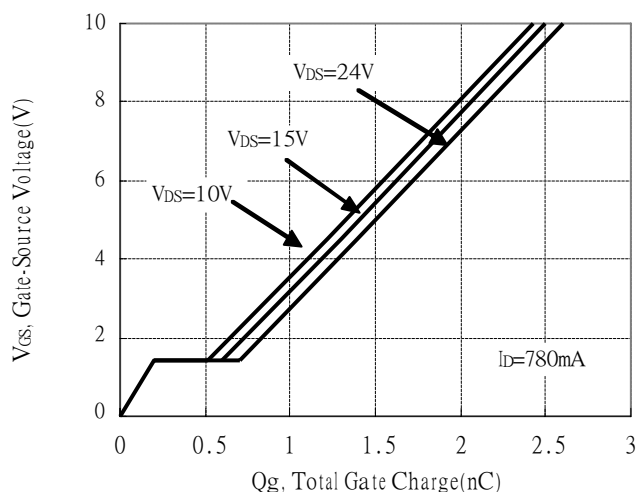
Threshold Voltage vs Junction Temperature



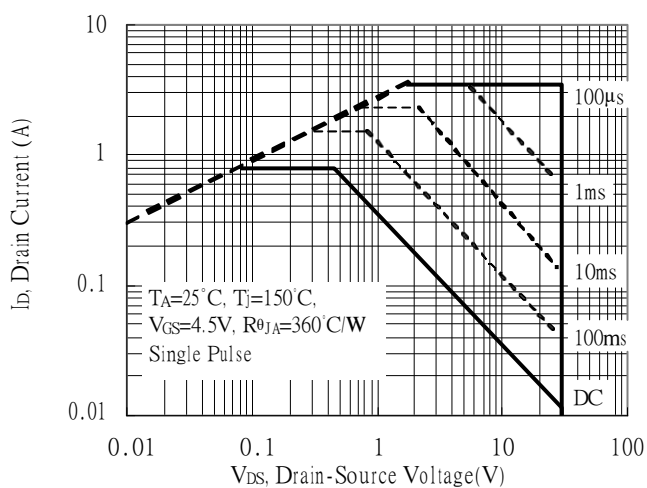
Single Pulse Power Rating, Junction to Ambient
 (Note on page 2)



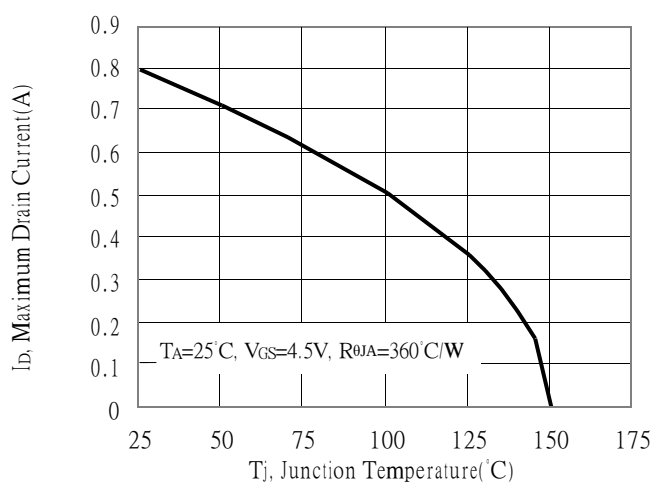
Gate Charge Characteristics



Maximum Safe Operating Area

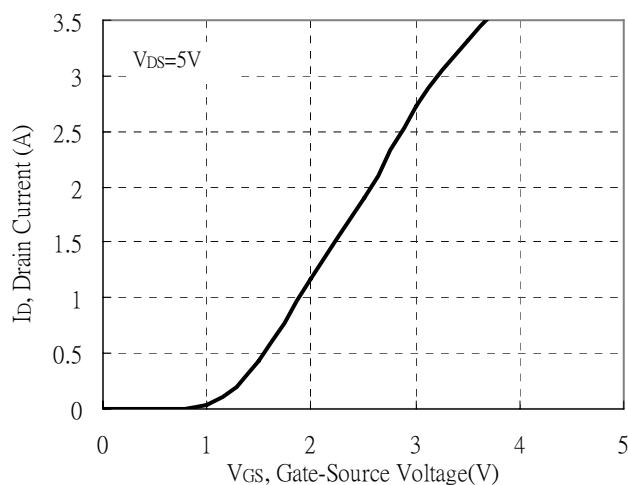


Maximum Drain Current vs Junction Temperature

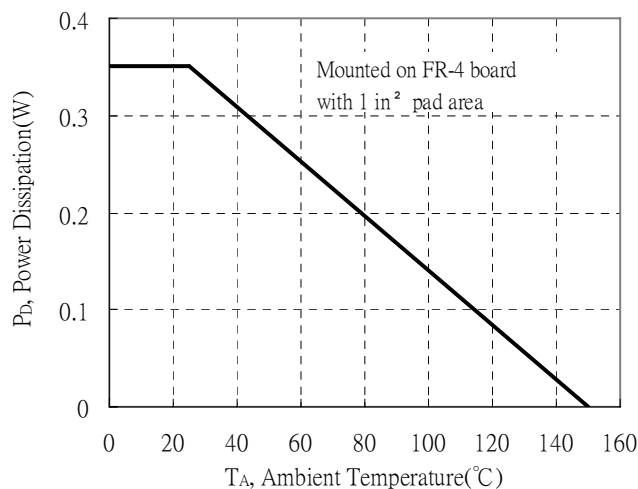


Typical Characteristics(Cont.)

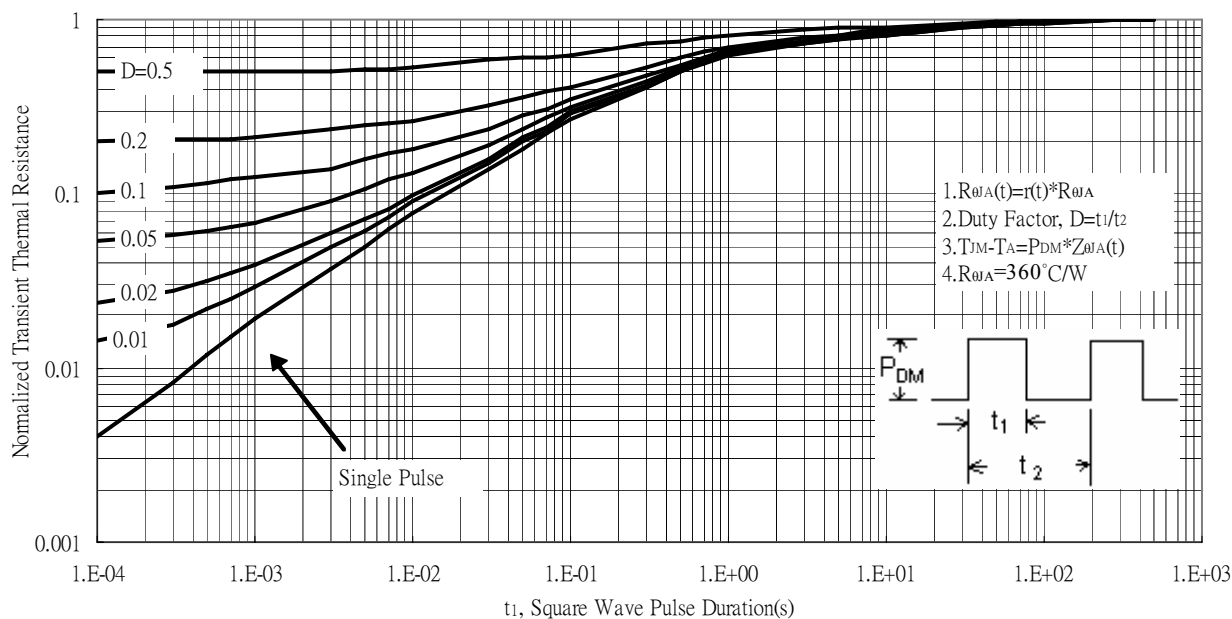
Typical Transfer Characteristics



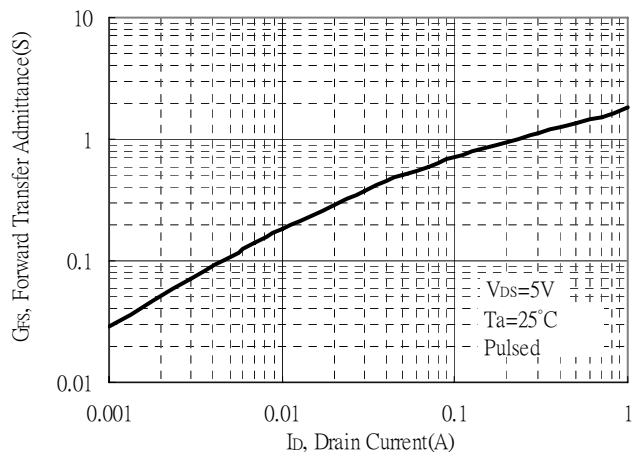
Power Derating Curve



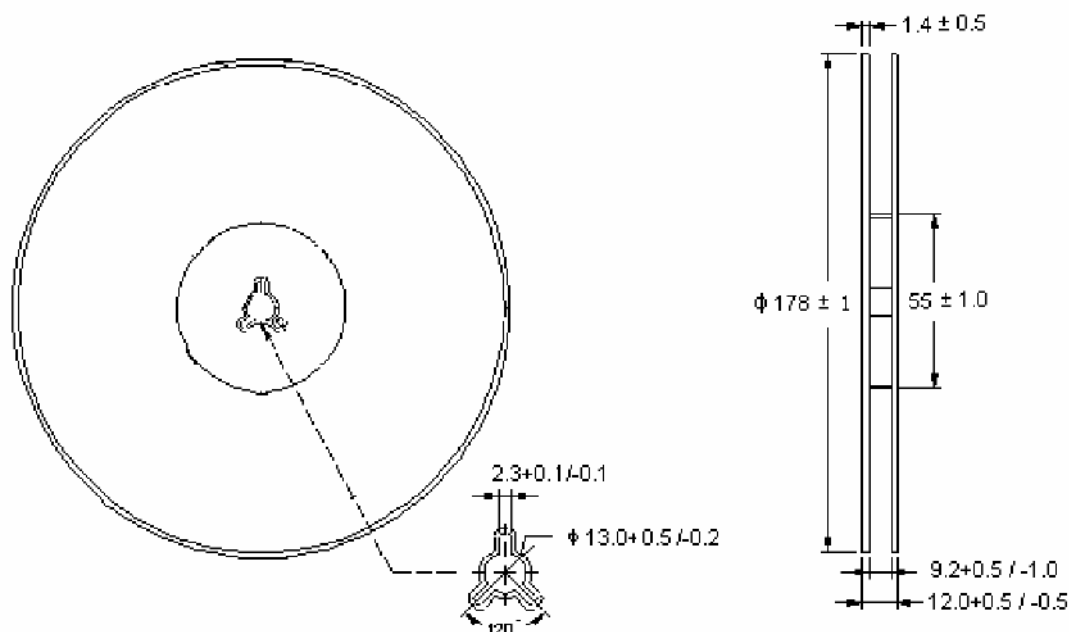
Transient Thermal Response Curves



Forward Transfer Admittance vs Drain Current

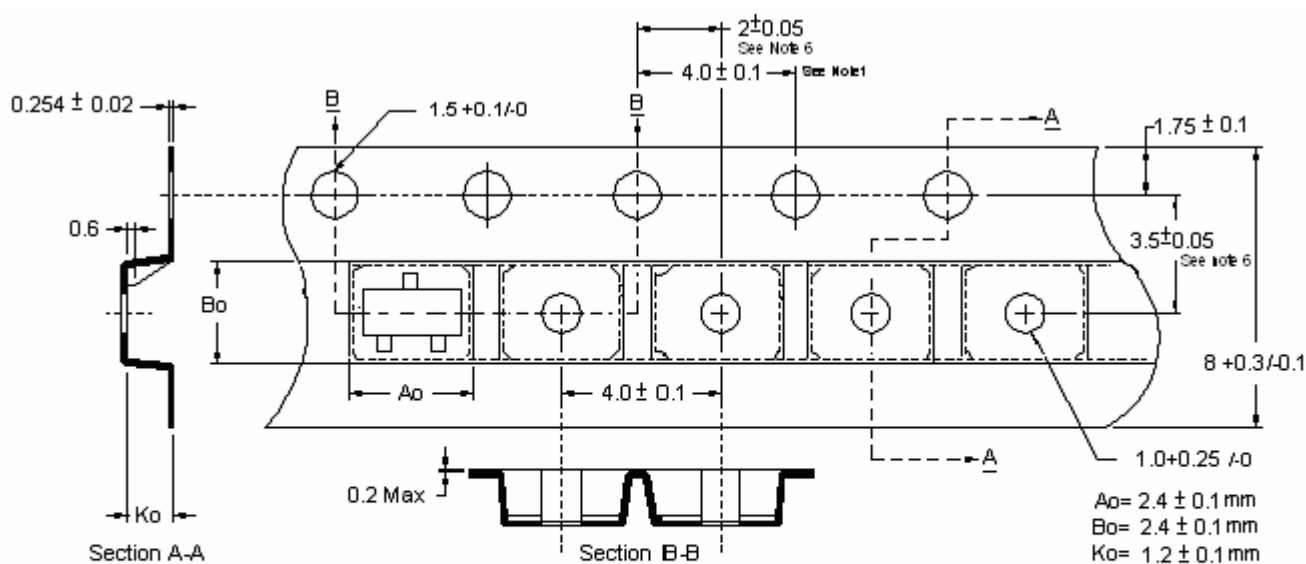


Reel Dimension



Unit: millimeter

Carrier Tape Dimension

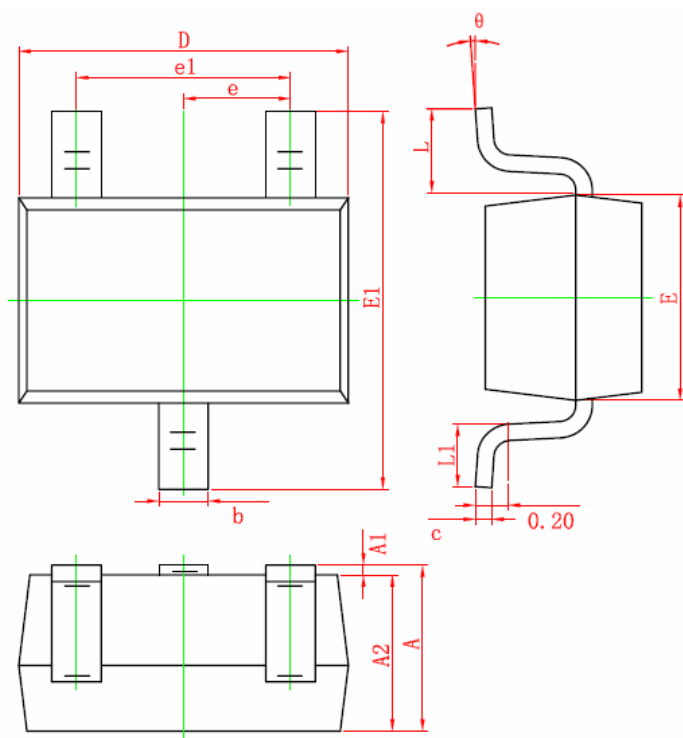


Notes

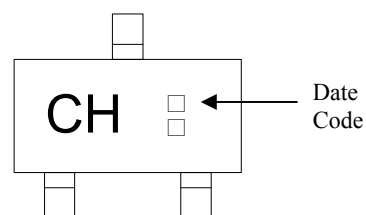
1. 10 sprocket hole pitch cumulative tolerance ± 0.2 .
2. Camber not to exceed 1mm in 100mm.
3. Material: Conductive Black Advantek Polystyrene.
4. A_0 & B_0 measured on a plane 0.3mm above the bottom of the pocket.
5. K_0 measured from a plane on the inside bottom of the pocket to the top surface of the carrier.
6. Pocket position relative to sprocket hole measured as true position of pocket, not pocket hole.

Unit : millimeter

SOT-323 Dimension



Marking:



3-Lead SOT-323 Plastic
Surface Mounted Package

Style: Pin 1.Gate 2.Source 3.Drain

DIM	Millimeters		Inches		DIM	Millimeters		Inches	
	Min.	Max.	Min.	Max.		Min.	Max.	Min.	Max.
A	0.900	1.100	0.035	0.043	E1	2.150	2.450	0.085	0.096
A1	0.000	0.100	0.000	0.004	e	0.650	TYP	0.026	TYP
A2	0.900	1.000	0.035	0.039	e1	1.200	1.400	0.047	0.055
b	0.200	0.400	0.008	0.016	L	0.525	REF	0.021	REF
c	0.080	0.150	0.003	0.006	L1	0.260	0.460	0.010	0.018
D	2.000	2.200	0.079	0.087	theta	0°	8°	0°	8°
E	1.150	1.350	0.045	0.053					